**Changkun LIU**

E-mail: changkun.liu@connect.ust.hk

**EDUCATION**

|  |  |
| --- | --- |
| **HKUST**  PhD in ***Computer Science and Engineering***  **Shanghai Jiao Tong University (SJTU)** | Sept. 2021 - now  Sept.2017 - Jun.2021 |
| Bachelor of Engineering in ***Electronic Science and Technology*** | |
|  | |
| **Summer Exchange Study: University of Washington (Seattle)** | July 2019 - Aug. 2019 |
| * Major in ***Electrical and Computer Engineering*** | |

**ACADEMIC RESEARCHES**

|  |  |
| --- | --- |
| **Real-time system task scheduling**  A conference paper is under review. (The only first author) | Apr. 2020- June 2021 |

**INTERNSHIP**

|  |  |
| --- | --- |
| **Intel Asia-Pacific** **R&D Ltd.** | Jun 2020 – May 2021 |
| *Software Engineer Intern, Dept. of IST, IOTG* | |
| * Participate in the function improvement and development of an Open source project StarlingX as the only intern in the StarlingX Team and the only undergraduate intern in IST department | |

**HONORS & AWARDS**

|  |  |
| --- | --- |
| Honorable Mention of 2019 Mathematical Contest in Modeling — International-class Top 25% | Oct. 2019 |
| Class C Scholarship of SJTU | 2018 |
| Class C Scholarship of SJTU | 2019 |

Class B Scholarship of SJTU 2020

Second-Class Scholarship Awarded by SCSK, Kabuskiki Kaisha. Top 4% 2020

Outstanding Graduate of Shanghai Jiao Tong University 2021

**TECHNICAL SKILLS**

|  |
| --- |
| * **Programming languages: C, C#, Python, C++, Java** * **Engineering tools: MATLAB, Unity, Ansible, Git, Latex** |